

March 1996

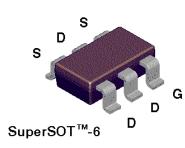
NDC651N N-Channel Logic Level Enhancement Mode Field Effect Transistor

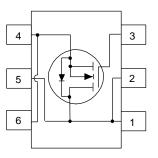
General Description

These N-Channel logic level enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is tailored to minimize on-state resistance. These devices are particularly suited for low voltage applications in notebook computers, portable phones, PCMICA cards, and other battery powered circuits where fast switching, and low in-line power loss are needed in a very small outline surface mount package.

Features

- 3.2A, 30V. $R_{DS(ON)} = 0.09\Omega$ @ $V_{GS} = 4.5V$ $R_{DS(ON)} = 0.06\Omega$ @ $V_{GS} = 10V.$
- Proprietary SuperSOTTM-6 package design using copper lead frame for superior thermal and electrical capabilities.
- High density cell design for extremely low R_{DS(ON)}.
- Exceptional on-resistance and maximum DC current capability.



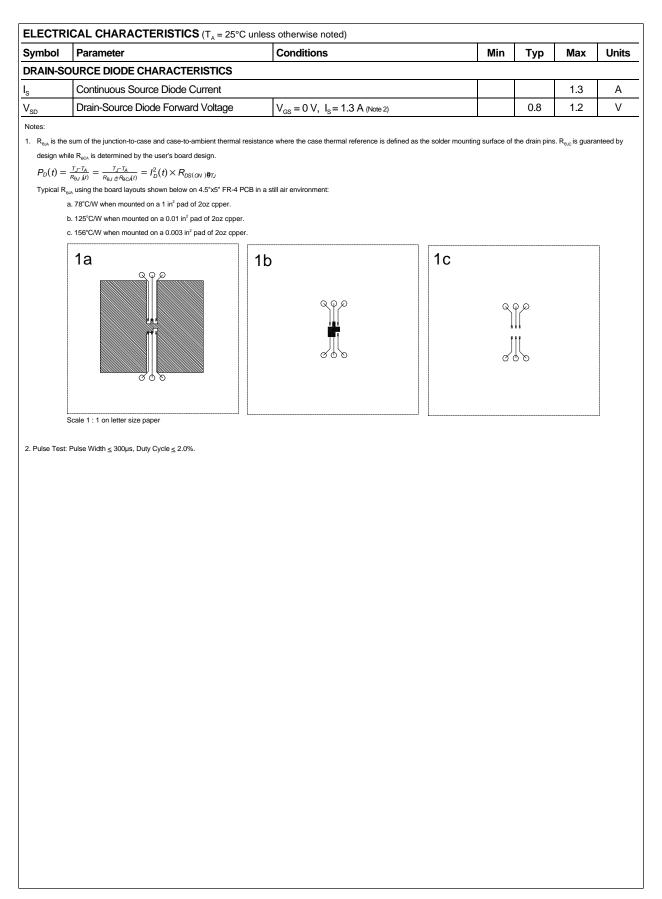


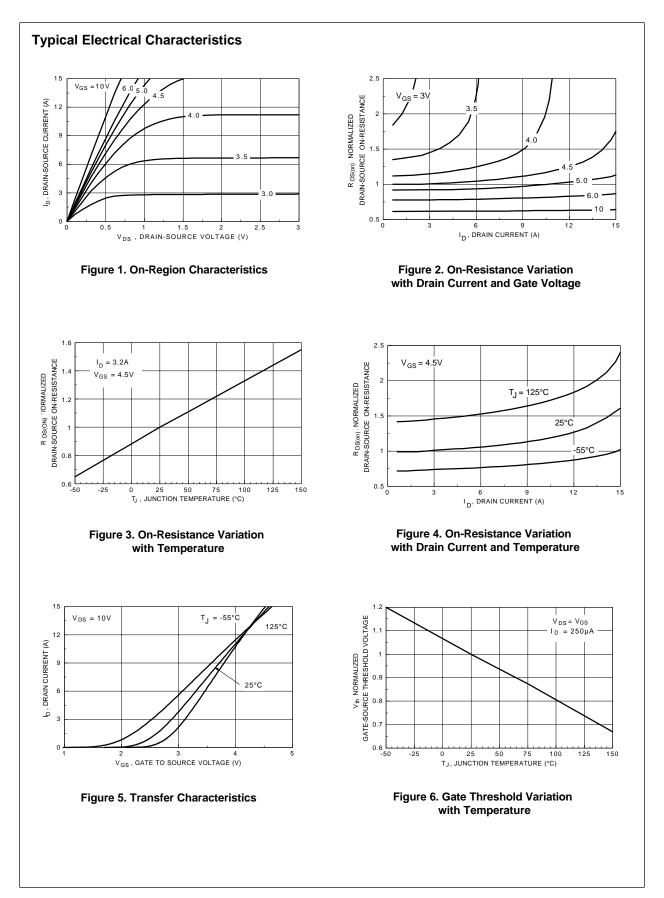
Absolute Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise note

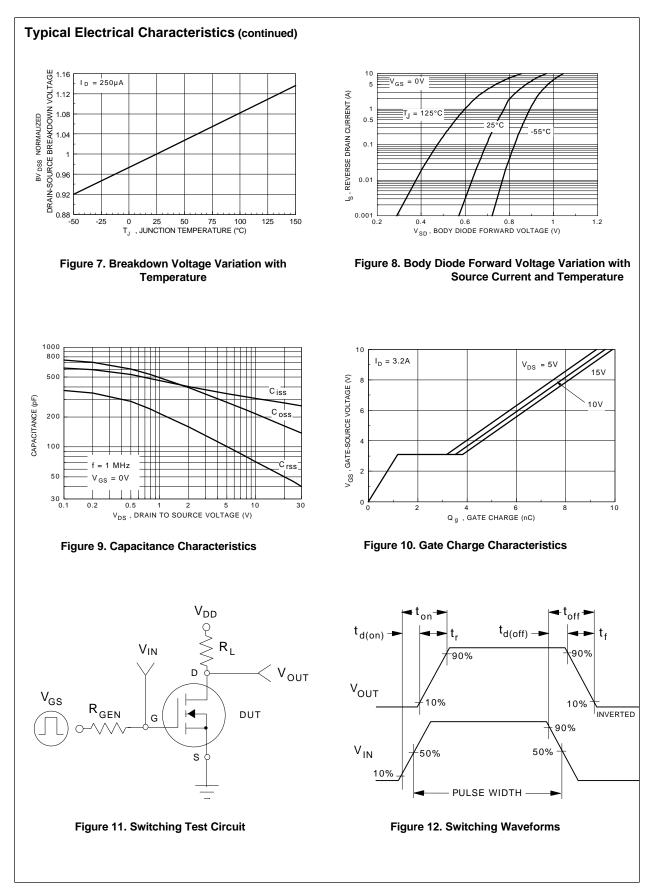
Symbol	Parameter		NDC651N	Units
V _{DSS}	Drain-Source Voltage		30	V
V _{GSS}	Gate-Source Voltage - Continuous		20	V
I _D	Drain Current - Continuous	(Note 1a)	3.2	A
	- Pulsed		15	
P _D	Maximum Power Dissipation	(Note 1a)	1.6	W
		(Note 1b)	1	
		(Note 1c)	0.8	
T_,T _{stg}	Operating and Storage Temperature Range		-55 to 150	°C
THERMA	AL CHARACTERISTICS			
R _{θJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
R _{øJC}	Thermal Resistance, Junction-to-Case	(Note 1)	30	°C/W

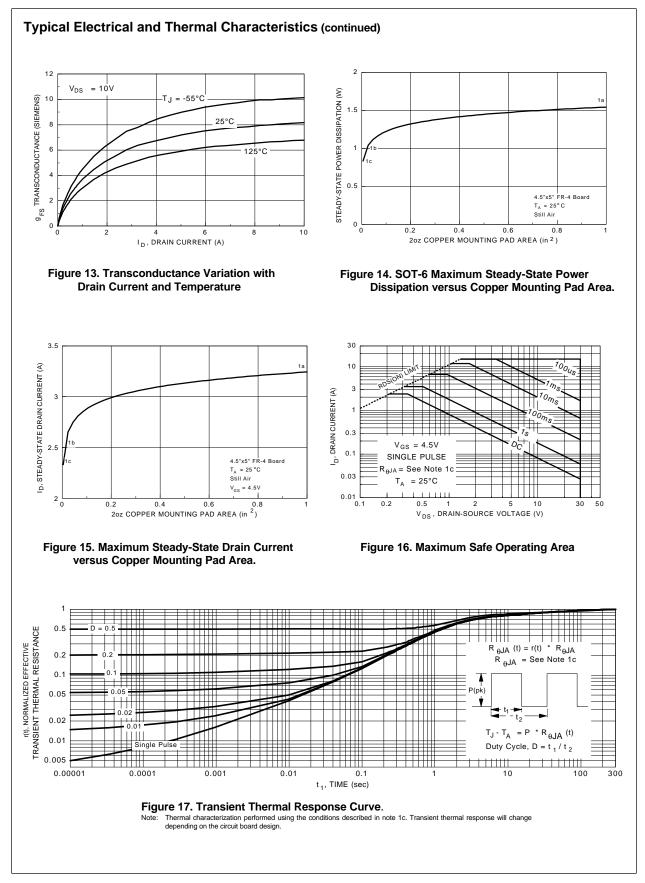
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Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		30			V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$				1	μA
			T _J = 55°C			10	μA
	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
ON CHAI	RACTERISTICS (Note 2)						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		1	1.7	3	V
			T _J = 125°C	0.7	1.3	2.2	
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 4.5 \text{ V}, I_{D} = 3.2 \text{ A}$			0.068	0.09	Ω
			T _J = 125°C		0.095	0.18	1
		$V_{GS} = 10 \text{ V}, \ I_{D} = 4 \text{ A}$			0.042	0.06	
I _{D(on)}	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$		10			Α
9 _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 3.2 \text{ A}$			6		S
DYNAMIC	CHARACTERISTICS						
C _{iss}	Input Capacitance	$V_{DS} = 15 \text{ V}, \ V_{GS} = 0 \text{ V},$ f = 1.0 MHz			290		pF
C _{oss}	Output Capacitance				180		pF
C _{rss}	Reverse Transfer Capacitance				60		pF
SWITCHI	NG CHARACTERISTICS (Note 2)						
t _{D(on)}	Turn - On Delay Time	$V_{\text{DD}} = 10 \text{ V}, I_{\text{D}} = 1 \text{ A},$ $V_{\text{GEN}} = 4.5 \text{ V}, $			9	20	ns
ţ,	Turn - On Rise Time				19	30	ns
t _{D(off)}	Turn - Off Delay Time				15	30	ns
t _r	Turn - Off Fall Time				7	20	ns
Q _g	Total Gate Charge	V _{DS} = 15 V,			10	20	nC
Q _{gs}	Gate-Source Charge	$I_{\rm D} = 3.2 \text{A}, V_{\rm GS} = 10 \text{V}$			1.2		nC
Q_{gd}	Gate-Drain Charge				2.6		nC









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